

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	WEI CHEN	04/13/2016
<b>RECEIVING PARTY DATA</b>		
<b>Name:</b>	SILERGY SEMICONDUCTOR TECHNOLOGY (HANGZHOU) LTD.	
<b>Street Address:</b>	A1501, TECHNOLOGY MANSION, EASTERN SOFTWARE PARK, NO. 90, WENSAN ROAD, ZHEJIANG PROVINCE	
<b>City:</b>	HANGZHOU	
<b>State/Country:</b>	CHINA	
<b>Postal Code:</b>	310012	
<b>PROPERTY NUMBERS Total: 1</b>		
	<b>Property Type</b>	<b>Number</b>
	Application Number:	15172544
<b>CORRESPONDENCE DATA</b>		
<b>Fax Number:</b>	(612)334-3312	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
<b>Phone:</b>	612-334-3222	
<b>Email:</b>	eguetzko@wck.com	
<b>Correspondent Name:</b>	JUDSON K. CHAMPLIN	
<b>Address Line 1:</b>	900 SECOND AVENUE SOUTH	
<b>Address Line 2:</b>	SUITE 1400	
<b>Address Line 4:</b>	MINNEAPOLIS, MINNESOTA 55402	
<b>ATTORNEY DOCKET NUMBER:</b>	S279.0038US1	
<b>NAME OF SUBMITTER:</b>	JUDSON K. CHAMPLIN	
<b>SIGNATURE:</b>	/Judson K. Champlin/	
<b>DATE SIGNED:</b>	06/03/2016	
<b>Total Attachments: 1</b>		
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# ASSIGNMENT

Attorney Docket No.

S279,0038US1

WHEREAS, I, Wei CHEN of Hangzhou, Zhejiang Province, CHINA (hereinafter referred to as ASSIGNOR), am the sole inventor of an invention described in an application for Letters Patent entitled SWITCHING MODE CONVERTER, the application having been executed on even date herewith, and/or being identifiable in the United States Patent and Trademark Office by Application No. 15/172,544, filed 03 June 2016; and


WHEREAS, Silergy Semiconductor Technology (Hangzhou) Ltd. (hereinafter referred to as ASSIGNEE), a corporation organized and existing under the laws of CHINA, and having offices at A1501, Technology Mansion, Eastern Software Park, No. 90, Wensan Road, Hangzhou, Zhejiang Province, CHINA 310012, is desirous of acquiring the entire right, title and interest in and to the invention, the application and any and all Letters Patent(s) or similar legal protection, foreign or domestic, to be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, I transfer to Assignee, its successors and assigns, my entire right, title and interest in and to the invention, the above-identified application(s), corresponding domestic and foreign applications claiming rights or benefits to the above-identified application(s) including non-provisional applications, continuation applications, continuing applications, divisional applications, reissue applications, reexamination applications, design applications and continuation-in-part applications, all Letters Patent(s) or similar legal protection issuing thereon, and all rights and benefits under any applicable treaty or convention, including all rights of priority; and I authorize the Director of the United States Patent and Trademark Office or foreign equivalent thereof to issue the Letters Patent or similar legal protection to the Assignee.

I authorize the Assignee, its successors and assigns, to insert in this instrument the filing date and serial number of the application when ascertained.

I authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent or similar legal protection, in its own name if desired, in any and all foreign countries.

I represent to the Assignee, its successors and assigns, that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I, my executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries.

  
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Signature of Inventor

Date : 2016.04.13

Wei CHEN  
\_\_\_\_\_  
Printed Name of Inventor

Residence of Inventor:  
A1501, Technology Mansion, Eastern Software Park,  
No. 90, Wensan Road, Hangzhou, Zhejiang Province  
310012 CHINA

Wanglin Huang  
\_\_\_\_\_  
Signature of Witness

Date : 2016.04.13

\_\_\_\_\_  
Printed Name of Witness

Residence of Witness:  
A1501, Technology Mansion, Eastern Software  
Park, No. 90, Wensan Road, Hangzhou,  
Zhejiang Province 310012 CHINA.